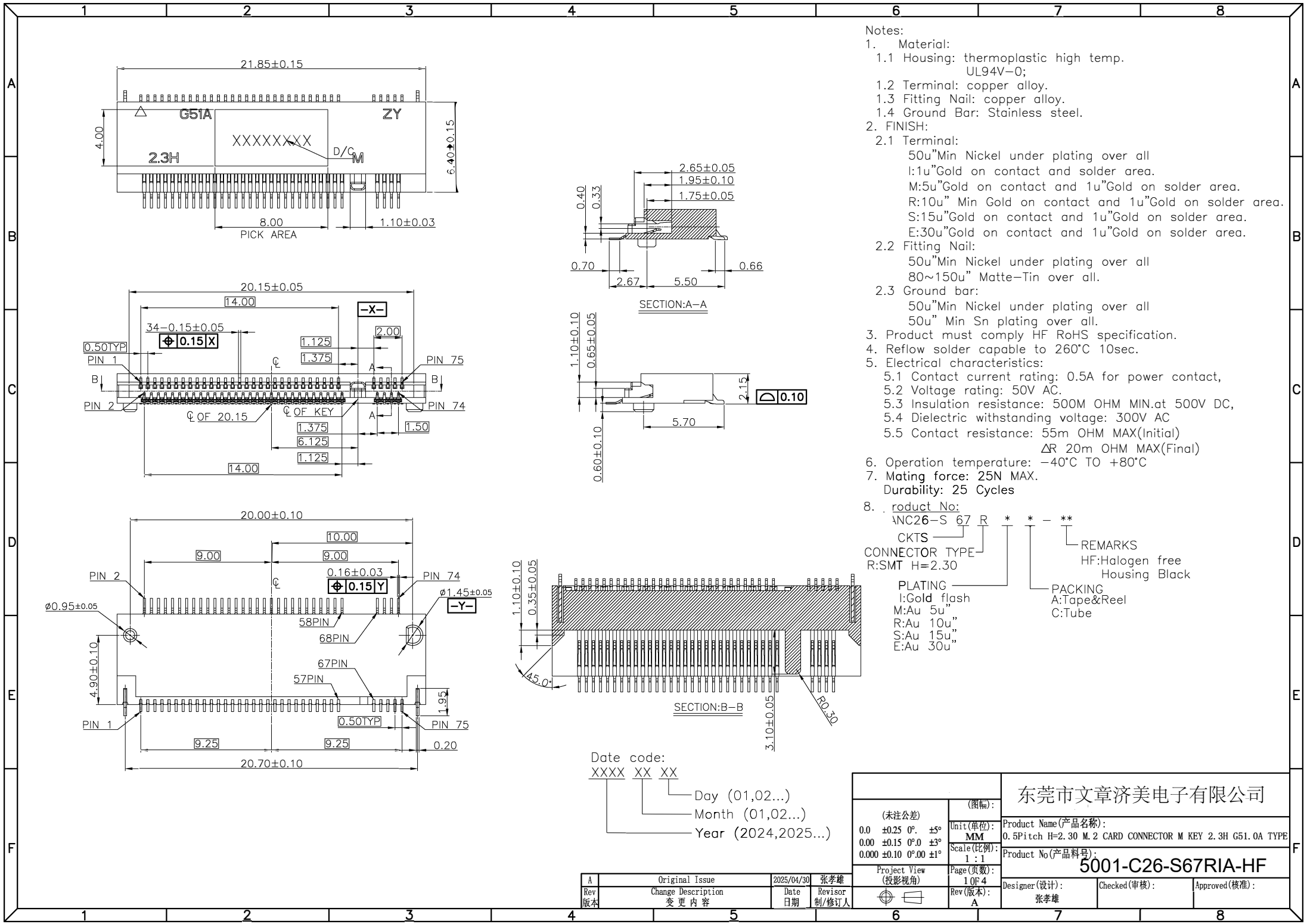
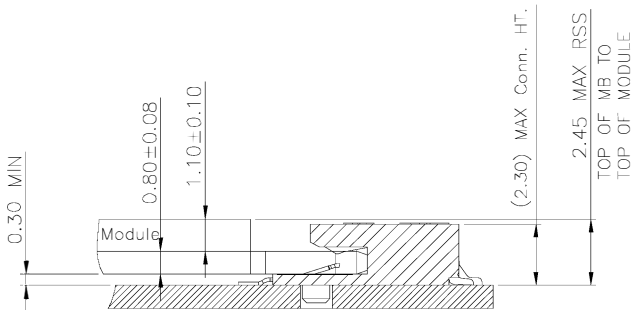




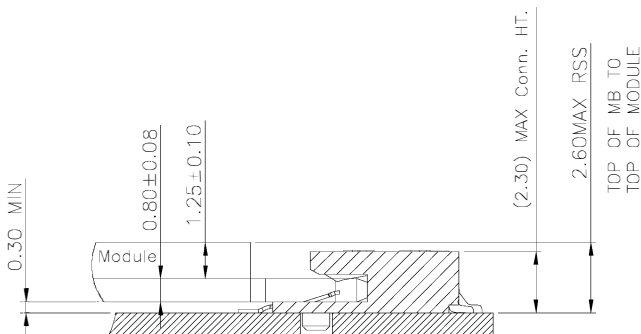
- Notes:
1. Material:
 - 1.1 Housing: thermoplastic high temp. UL94V-0;
 - 1.2 Terminal: copper alloy.
 - 1.3 Fitting Nail: copper alloy.
 - 1.4 Ground Bar: Stainless steel.
 2. FINISH:
 - 2.1 Terminal:
 - 50u"Min Nickel under plating over all
 - 1:1u"Gold on contact and solder area.
 - M:5u"Gold on contact and 1u"Gold on solder area.
 - R:10u" Min Gold on contact and 1u"Gold on solder area.
 - S:15u"Gold on contact and 1u"Gold on solder area.
 - E:30u"Gold on contact and 1u"Gold on solder area.
 - 2.2 Fitting Nail:
 - 50u"Min Nickel under plating over all
 - 80~150u" Matte-Tin over all.
 - 2.3 Ground bar:
 - 50u"Min Nickel under plating over all
 - 50u" Min Sn plating over all.
 3. Product must comply HF RoHS specification.
 4. Reflow solder capable to 260°C 10sec.
 5. Electrical characteristics:
 - 5.1 Contact current rating: 0.5A for power contact,
 - 5.2 Voltage rating: 50V AC.
 - 5.3 Insulation resistance: 500M OHM MIN.at 500V DC,
 - 5.4 Dielectric withstanding voltage: 300V AC
 - 5.5 Contact resistance: 55m OHM MAX(Initial)
ΔR 20m OHM MAX(Final)
 6. Operation temperature: -40°C TO +80°C
 7. Mating force: 25N MAX.
Durability: 25 Cycles
 8. Product No:
INC26-S 67 R * * - **
CKTS
CONNECTOR TYPE
R:SMT H=2.30
PLATING
I:Gold flash
M:Au 5u"
R:Au 10u"
S:Au 15u"
E:Au 30u"
REMARKS
HF:Halogen free
Housing Black
PACKING
A:Tape&Reel
C:Tube

Date code:
XXXX XX XX
Day (01,02...)
Month (01,02...)
Year (2024,2025...)

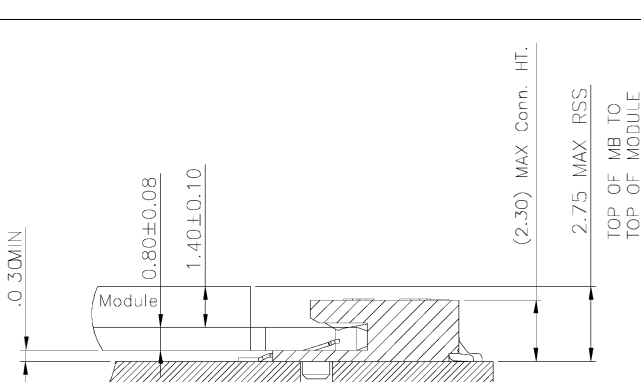
(未注公差)		(图幅):	东莞市文章济美电子有限公司	
0.0	±0.25 0° ±5°	Unit(单位):	Product Name(产品名称):	
0.00	±0.15 0° 0 ±3°	MM	0.5Pitch H=2.30 M.2 CARD CONNECTOR M KEY 2.3H G51.0A TYPE	
0.000	±0.10 0° 0.00 ±1°	Scale(比例):	Product No(产品料号):	
		1 : 1	5001-C26-S67RIA-HF	
Project View		Page(页数):	Designer(设计):	
(投影视角)		1 OF 4	张孝雄	
Rev		Rev(版本):	Checked(审核):	
版本		A	Approved(核准):	
Original Issue		2025/04/30	张孝雄	
Change Description		张孝雄		
变更内容		制/修订人		
		日期		
		制/修订人		



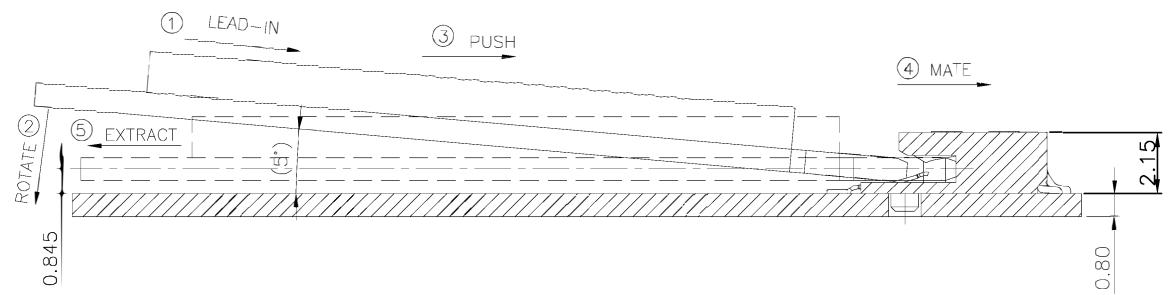
Stack-up Top Mount Single Sided Module
for 1.20 max top-side component height



Stack-up Top Mount Single Sided Module
for 1.35 max top-side component height



Stack-up Top Mount Single Sided Module
for 1.5 max top-side component height



HOW TO MATE AND EXTRACT
=====

MATE: (1) → (4)

EXTRACT: (5)

NOTE: Mating force will generate from step 3 to step 4.

CUSTOMER DRAWING				东莞市文章济美电子有限公司		
Tolerance Unspecified (未注公差)		Size(图幅):		Product Name(产品名称):		
0.0	±0.25 0° ±5°	Unit(单位):		0.5Pitch H=2.30 M.2 CARD CONNECTOR M KEY 2.3H G51.0A TYPE		
0.00	±0.15 0° 0 ±3°	MM		Product No(产品料号):		
0.000	±0.10 0° 00 ±1°	Scale(比例):		5001-C26-S67RIA-HF		
		1:1				
Project View (投影视角)		Page(页数):		Designer(设计):		
		2 OF 4		张孝雄		
		Rev(版本):		Checked(审核):		
		A		Approved(核准):		

A	Original Issue	2025/04/30	张孝雄
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